CNY17-1, CNY17-2, CNY17-3, CNY17-4
CNY17F-1, CNY17F-2, CNY17F-3, CNY17F-4
DC Input 6-Pin Phototransistor Optocoupler

Features

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range - 55 ℃ to 110 ℃
- Regulatory Approvals
  - UL - UL1577 (E364000)
  - VDE - EN60747-5-5(VDE0884-5)
  - CQC – GB4943.1, GB8898
  - IEC60065, IEC60950

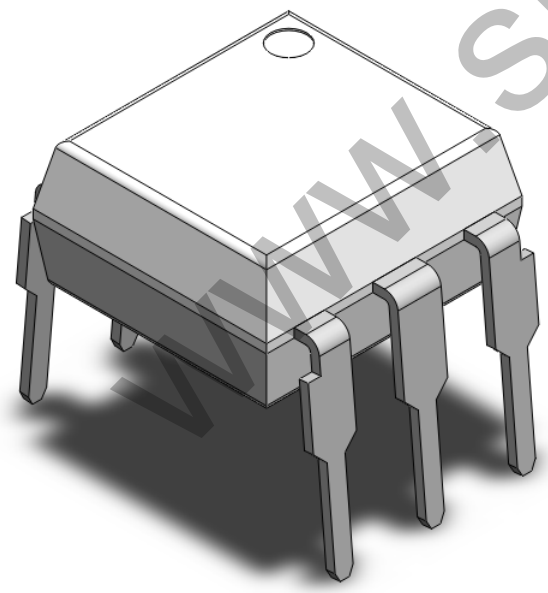
Description

The CNY17 and CNY17F series consists of a photo transistor optically coupled to a gallium arsenide Infrared-emitting diode in a 6-lead DIP package with different lead forming options.

Applications

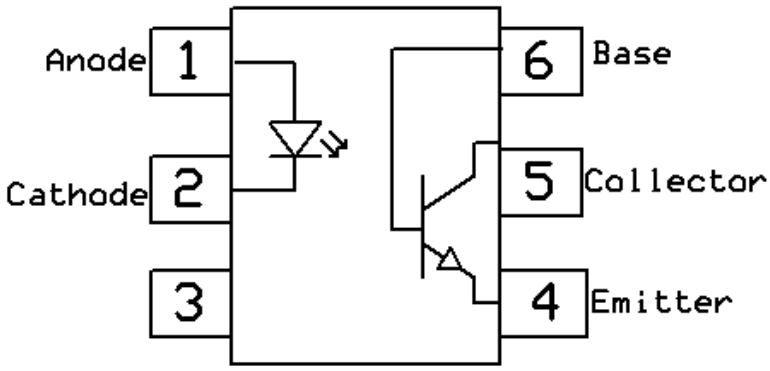
- Switch mode power supplies
- Computer peripheral interface
- Microprocessor system interface

Package Outline



Note: Different lead forming options available. See package dimension.

Schematic



Note: CNY17F without Base Connection

Absolute Maximum Rating at 25°C

Symbol	*Parameters*	*Ratings*	*Units*	*Notes*
V_{ISO}	Isolation voltage	5000	V_{RMS}	
T_{OPR}	Operating temperature	-55 ~ +110	°C	
T_{STG}	Storage temperature	-55 ~ +150	°C	
T_{SOL}	Soldering temperature	260	°C	
Emitter				
I_F	Forward current	60	mA	
$I_{F(TRANS)}$	Peak transient current (≤1μs P.W,300pps)	1	A	
V_R	Reverse voltage	6	V	
P_D	Power dissipation	100	mW	
Detector				
P_D	Power dissipation	150	mW	
B_{VCEO}	Collector-Emitter Breakdown Voltage	80	V	
B_{VCBO}	Collector-Base Breakdown Voltage	80	V	
B_{VECO}	Emitter-Collector Breakdown Voltage	7	V	
B_{VEBO}	Emitter-Base Breakdown Voltage	7	V	

Electrical Characteristics T_A = 25℃ (unless otherwise specified)

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Typ	Max	Units	Notes
V_F	Forward voltage	I_F=10mA		1.24	1.4	V	
I_R	Reverse Current	V_R = 6V	-	-	5	μA	
C_{IN}	Input Capacitance	f= 1MHz	-	20	-	pF	

Detector Characteristics

Symbol	Parameters		Test Conditions	Min	Typ	Max	Units	Notes
B_{VCEO}	Collector-Emitter Breakdown		I_C= 0.1mA	80	-	-	V	
B_{VECO}	Emitter-Collector Breakdown		I_E= 0.1mA	7	-	-	V	
B_{VCBO}	Collector-Base Breakdown	CNY17-1/2/3/4	I_C= 0.1mA	80	-	-	V	
B_{VEBO}	Emitter-Base Breakdown		I_E= 0.1mA	7	-	-	V	
I_{CEO}	Collector-Emitter Dark Current		V_{CE}= 10V, I_F=0mA	-	-	50	nA	
I_{CBO}	Collector-Base Dark Current	CNY17-1/2/3/4	V_{CB}= 10V, I_F=0mA	-	-	20	nA	

Transfer Characteristics

Symbol	Parameters		Test Conditions	Min	Typ	Max	Units	Notes
CTR	Current Transfer Ratio	CNY17-1,CNY17F-1	I_F= 10mA, V_{CE}= 5V	40	-	80	%	
		CNY17-2,CNY17F-2		63	-	125		
		CNY17-3,CNY17F-3		100	-	200		
		CNY17-4,CNY17F-4		160	-	320		
		CNY17-1,CNY17F-1	I_F= 1mA, V_{CE}= 5V	13	-	-		
		CNY17-2,CNY17F-2		22	-	-		
		CNY17-3,CNY17F-3		34	-	-		
		CNY17-4,CNY17F-4		56	-	-		
$V_{CE(SAT)}$	Collector- Emitter Saturation Voltage		I_F= 10mA, I_C= 2.5mA	-	-	0.3	V	
R_{IO}	Isolation Resistance		V_{IO}= 500V_{DC}	$1x10^{11}$	-	-	Ω	
C_{IO}	Isolation Capacitance		f= 1MHz	-	0.25	-	pF	

Switching Characteristics

Symbol	*Parameters*	*Test Conditions*	*Min*	*Typ*	*Max*	*Units*	*Notes*
T_{ON}	Turn On Time	I_C= 2mA, V_{CC}= 10V, R_L= 100	-	4.3	11.5	µs	
t_r	Rise Time		-	9.8	9.8		
T_{OFF}	Turn Off Time		-	3.9	11.5	µs	
t_f	Fall Time		-	6.9	9.8		

Typical Characteristic Curves

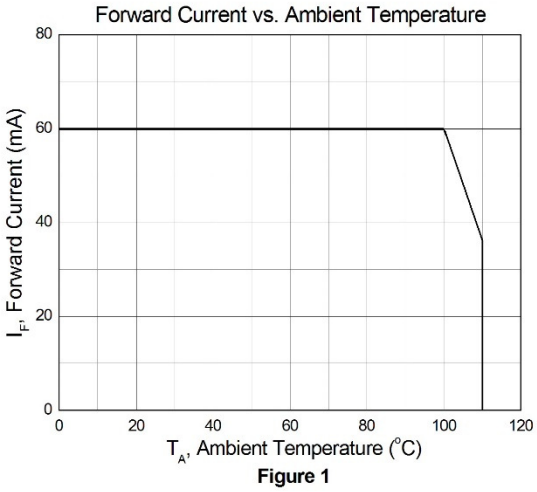


Figure 1

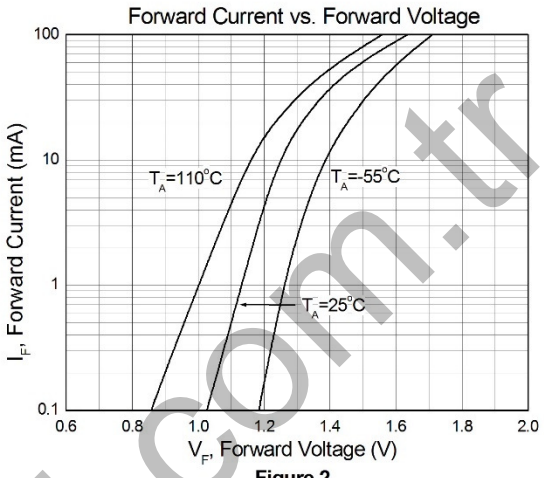


Figure 2

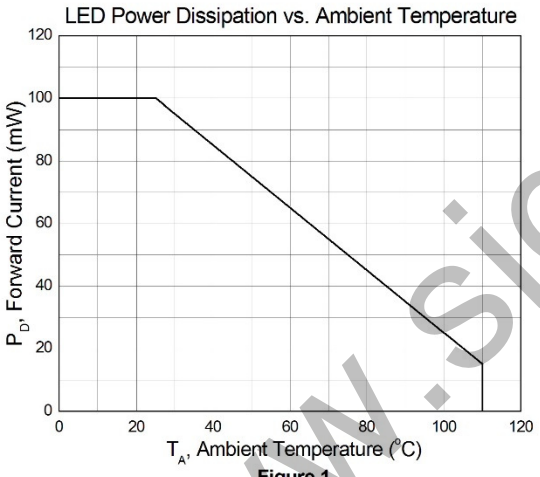


Figure 1

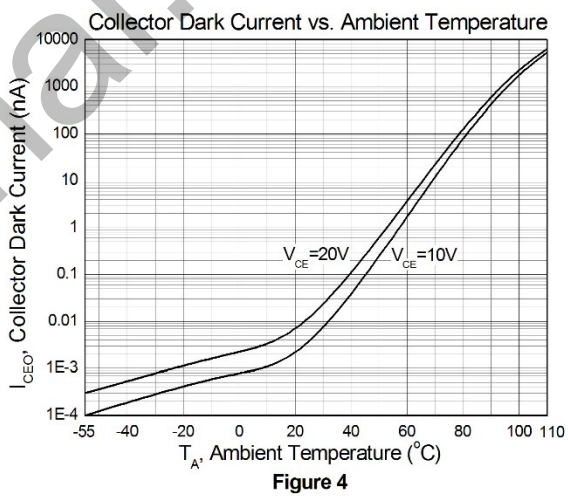


Figure 4

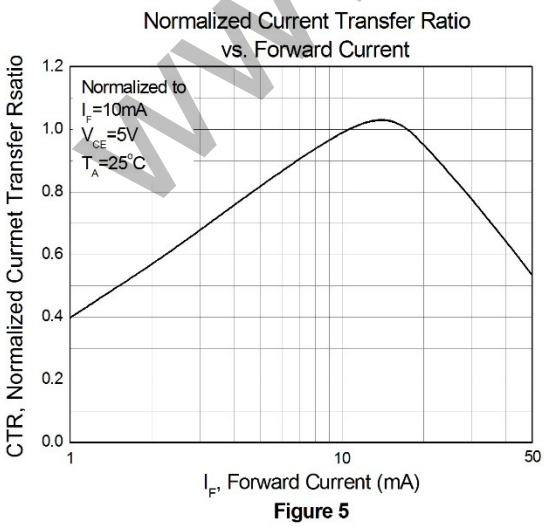


Figure 5

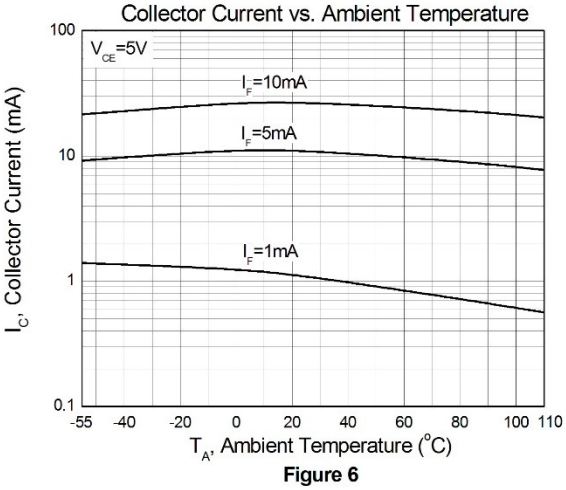


Figure 6

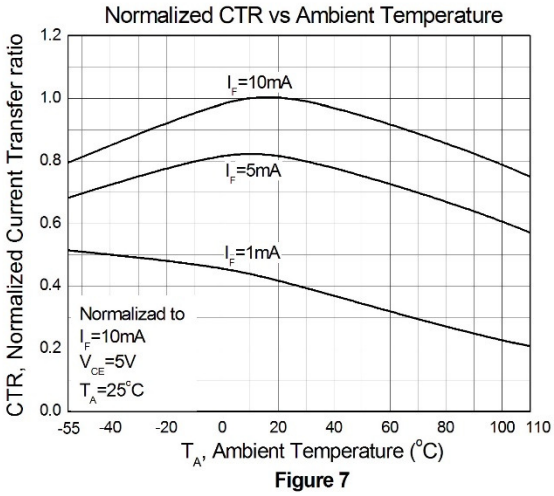


Figure 7

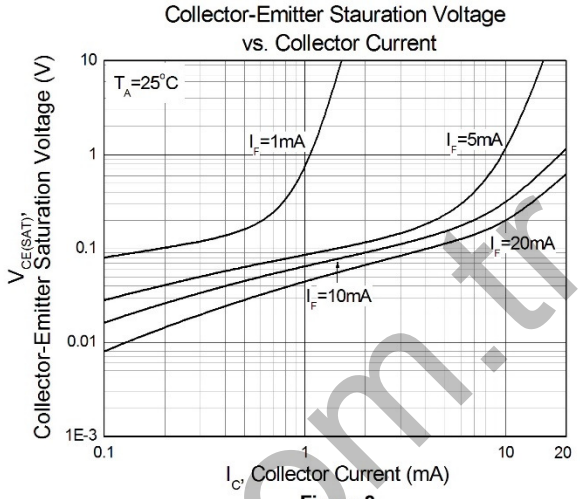


Figure 8

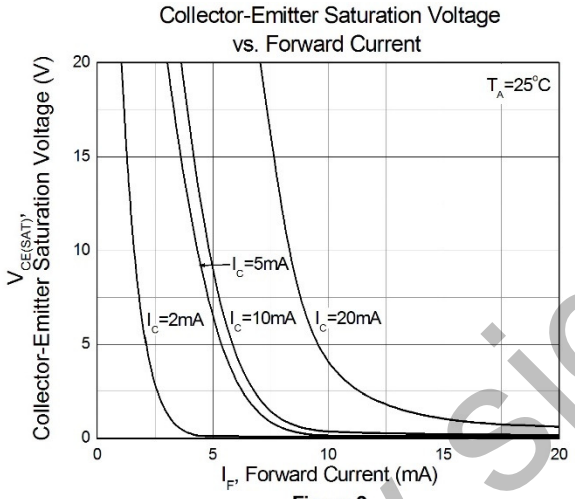


Figure 9

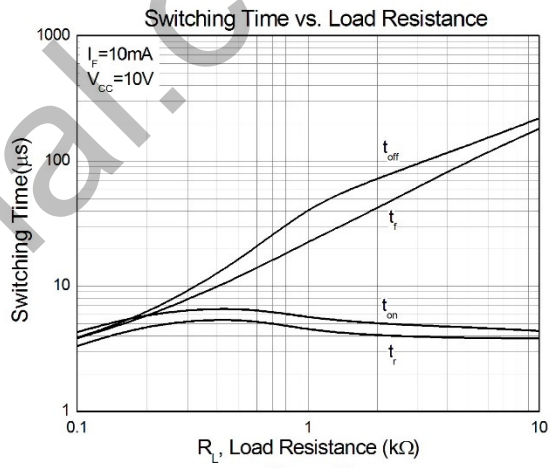


Figure 10

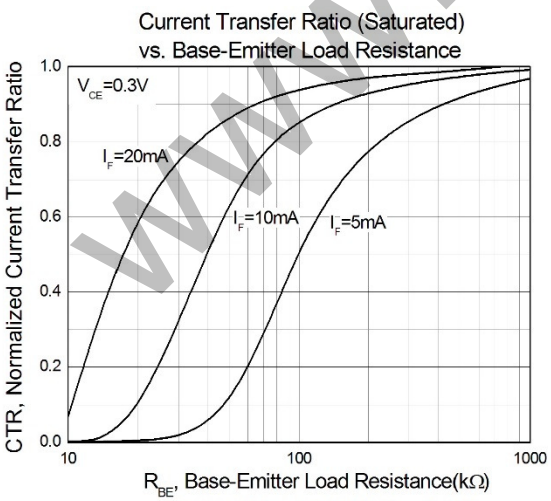


Figure 11(For CNY17 Series Only)

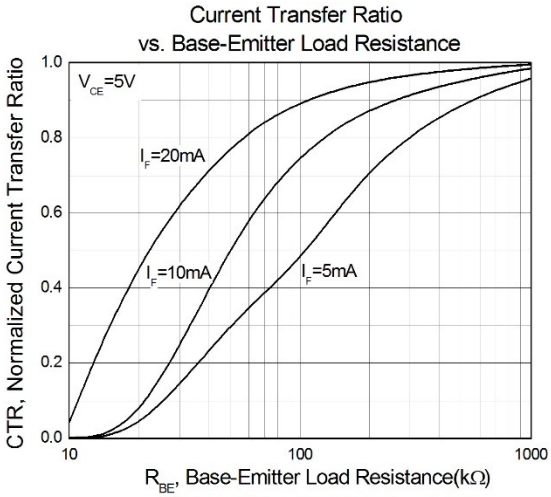


Figure 12(For CNY17 Series Only)

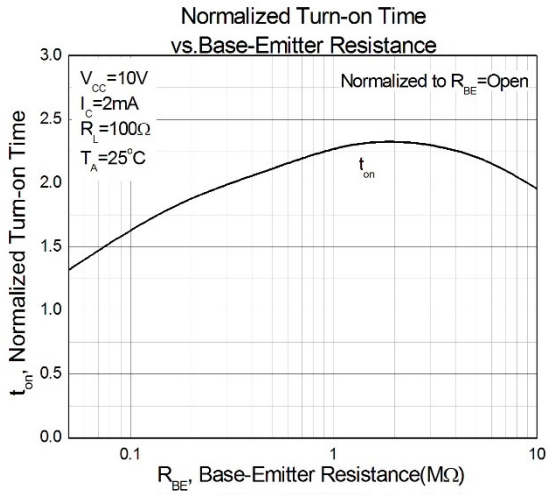


Figure 13(For CNY17 Series Only)

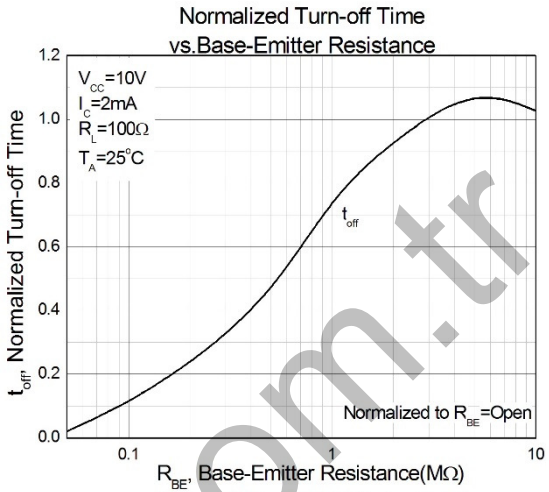
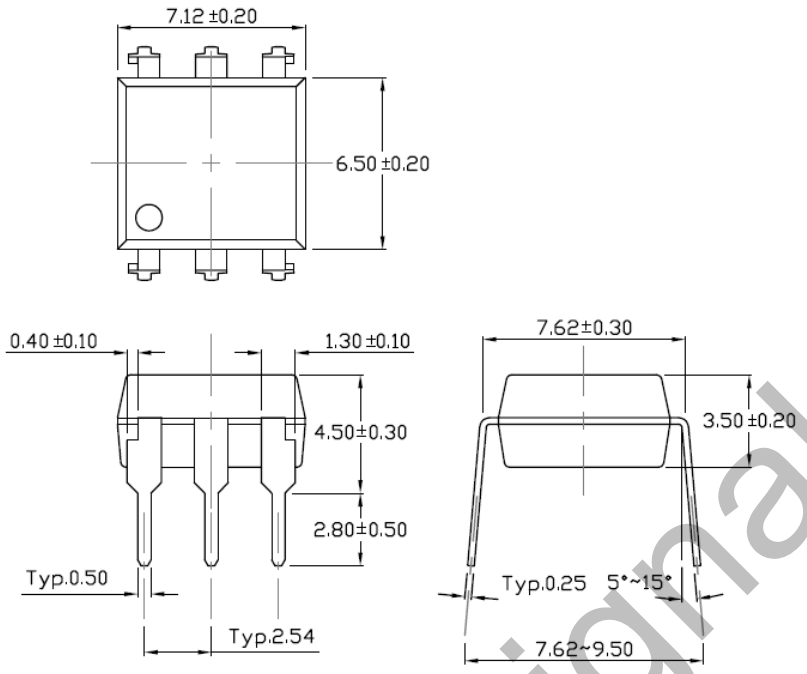


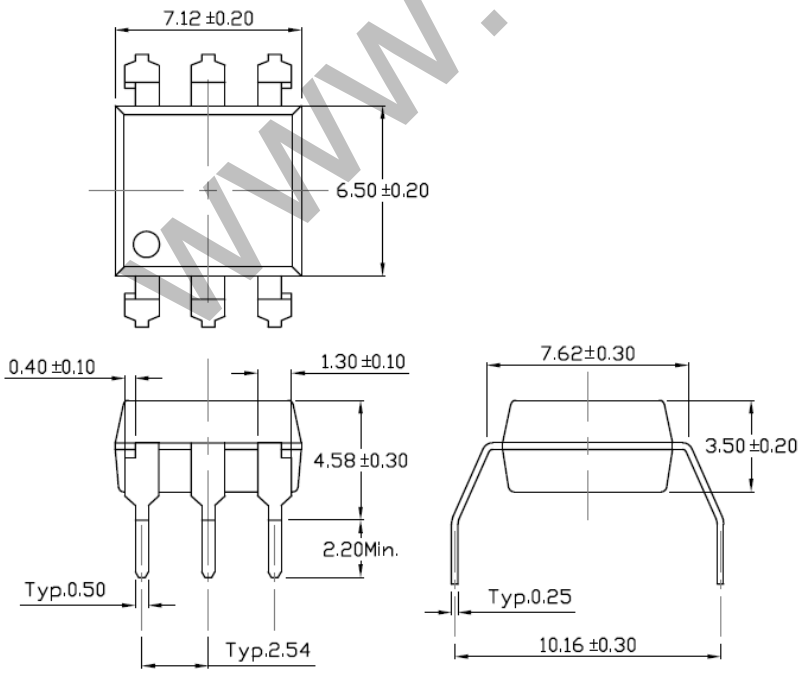
Figure 14(For CNY17 Series Only)

Package Dimension *Dimensions in mm unless otherwise stated*

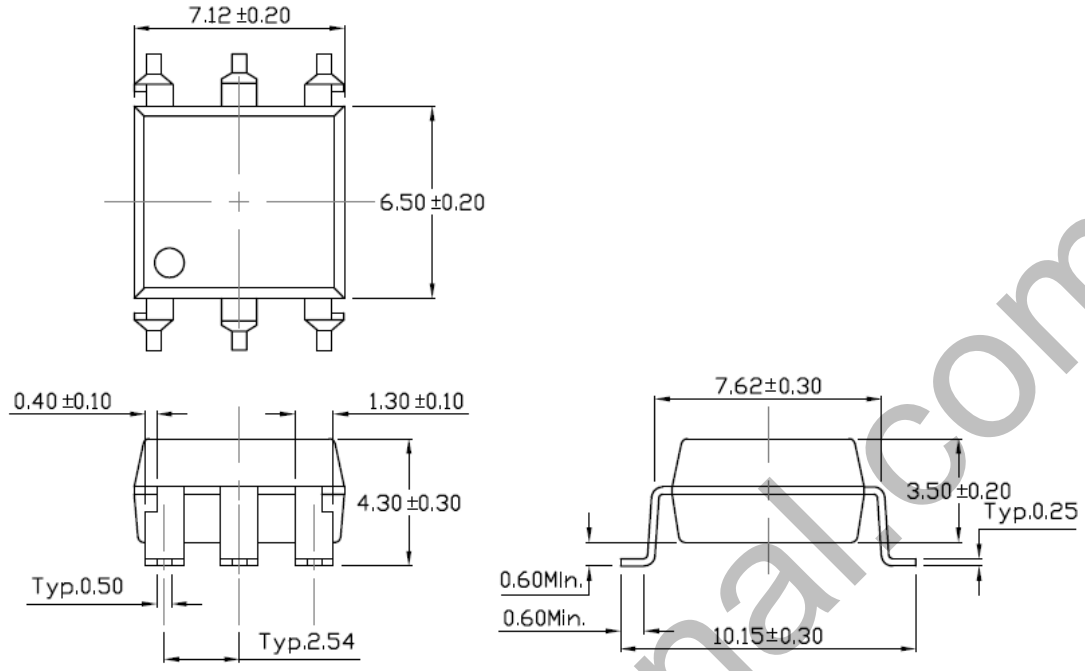
Standard DIP – Through Hole



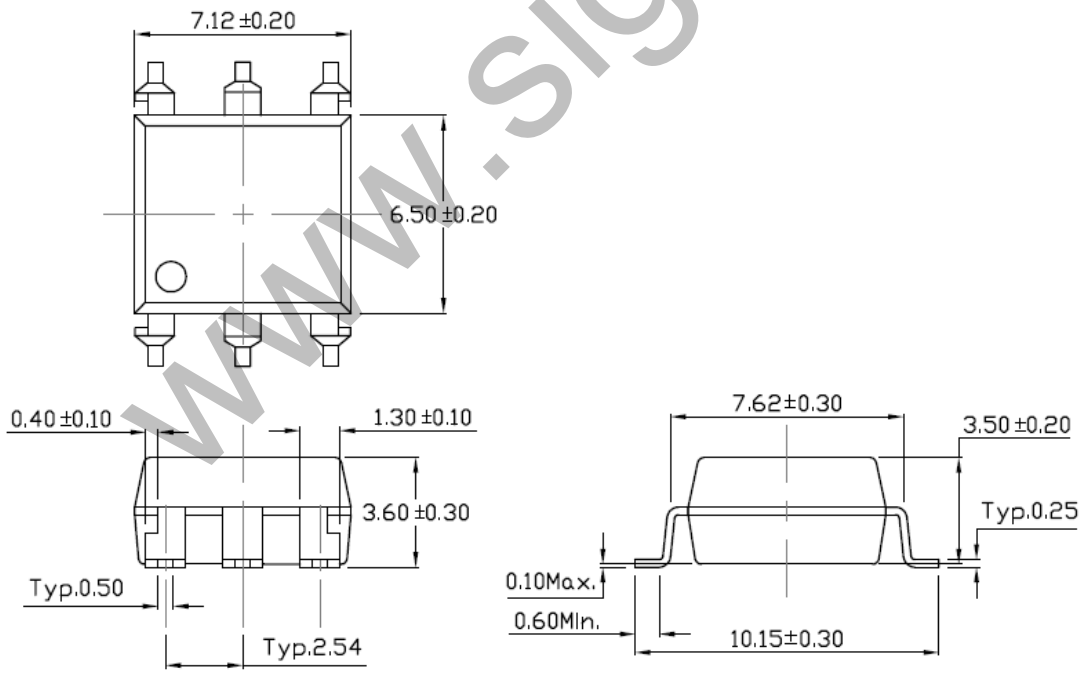
Wide Lead Forming – Through Hole (M Type)



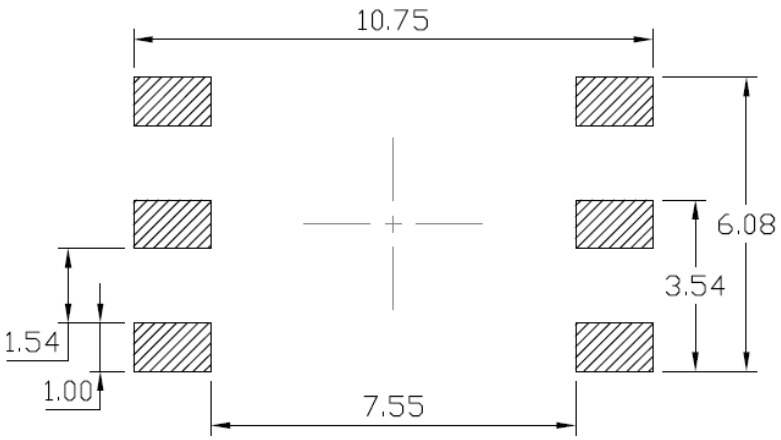
Surface Mount Forming (S Type)



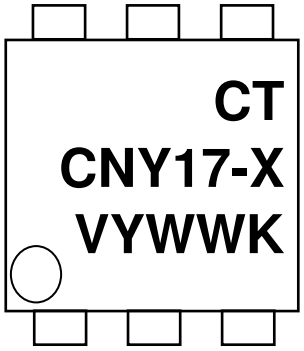
Surface Mount Forming (Low Profile) (SL Type)

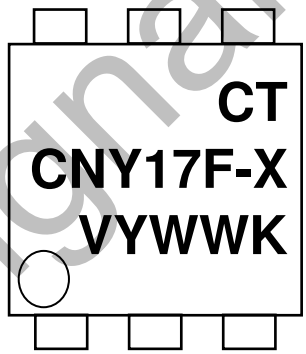


Recommended Solder Mask *Dimensions in mm unless otherwise stated*



Marking Information





Note:

CT : Denotes “CT Micro”
CNY17-X : Part Number
X : CTR Rank
V : VDE Option
Y : Fiscal Year
WW : Work Week
K : Manufacturing Code

Ordering Information

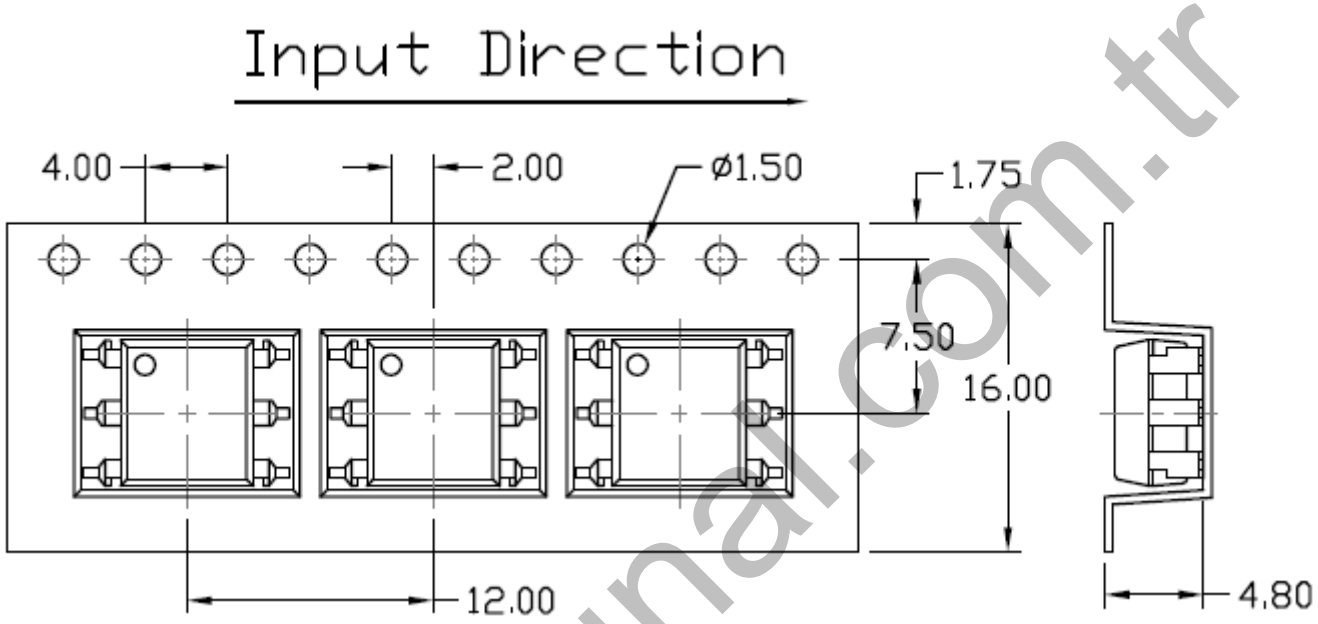
CNY17-X(V)(Y)(Z)-G, CNY17F-X(V)(Y)(Z)-G

X = Part No. (1,2,3,4)
Y = Lead form option (S, SL, M or none)
Z = Tape and reel option (T1, T2 or none)
G= Material option (G: Green, None: Non-green)

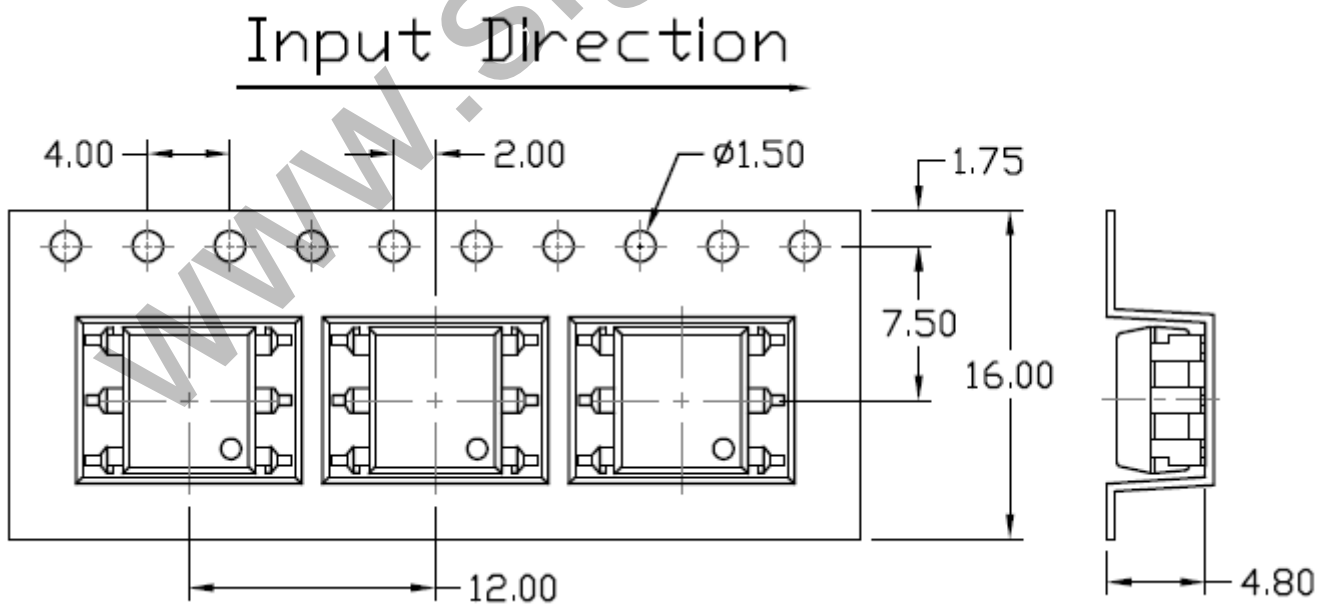
Option	***Description***	***Quantity***
None	Standard 6 Pin Dip	50Units/Tube
M	Gullwing (400mil) Lead Forming	50Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming– With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming – With Option 2 Taping	1000 Units/Reel

Carrier Tape Specifications *Dimensions in mm unless otherwise stated*

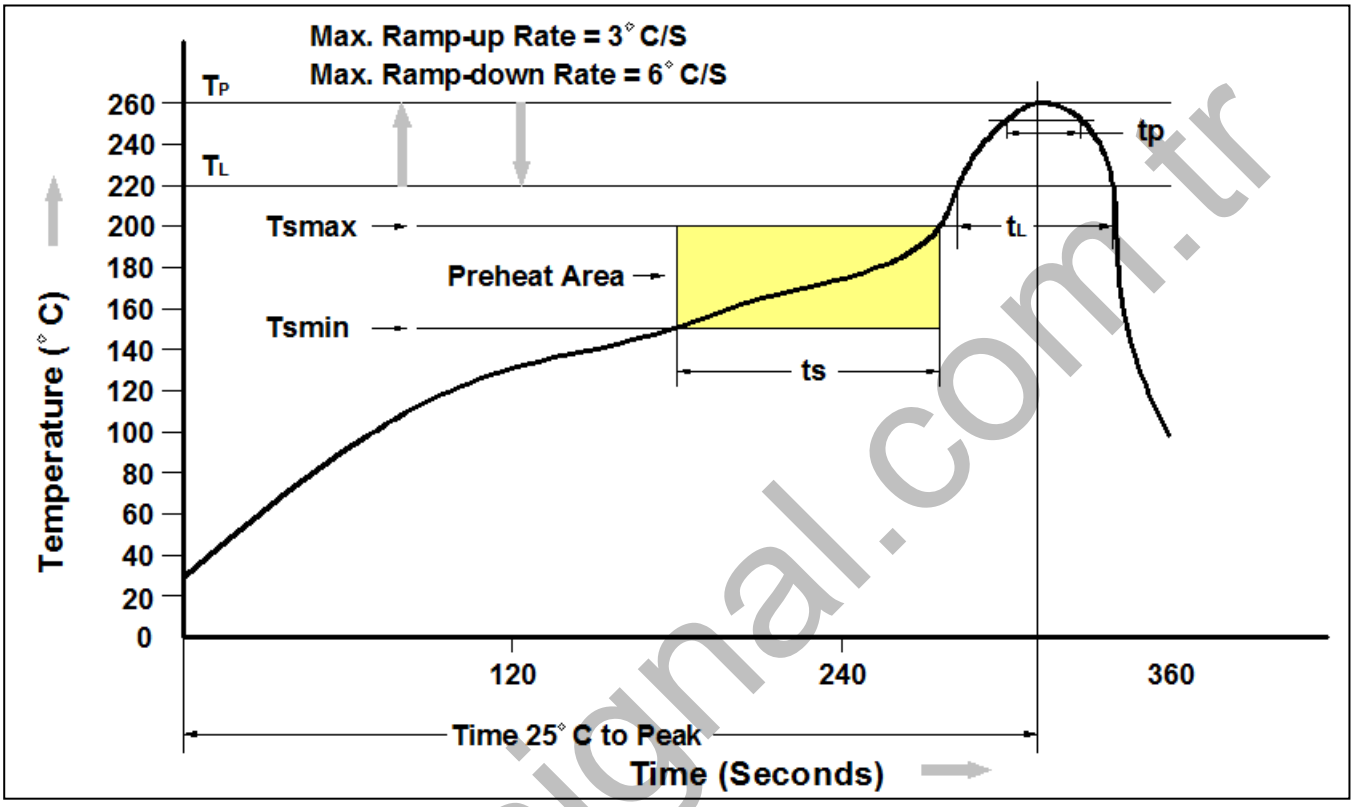
Option S(T1) & SL(T1)



Option S(T2) & SL(T2)



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150℃
Temperature Max. (Tsmax)	200℃
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t_L to t_P)	3℃/second max.
Liquidous Temperature (T_L)	217℃
Time (t_L) Maintained Above (T_L)	60 – 150 seconds
Peak Body Package Temperature	260℃ +0℃ / -5℃
Time (t_P) within 5℃ of 260℃	30 seconds
Ramp-down Rate (T_P to T_L)	6℃/second max
Time 25℃ to Peak Temperature	8 minutes max.

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